# VS-2EFH02-M3

**Vishay Semiconductors** 

# Hyperfast Rectifier, 2 A FRED Pt®



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## LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                        |                |  |  |  |  |
|--|----------------|--|--|--|--|
| I <sub>F(AV)</sub>                             | 2 A            |  |  |  |  |
| V <sub>R</sub>                                 | 200 V          |  |  |  |  |
| V <sub>F</sub> at I <sub>F</sub> (typ. 125 °C) | 0.75 V         |  |  |  |  |
| t <sub>rr</sub>                                | 25 ns          |  |  |  |  |
| T <sub>J</sub> max.                            | 175 °C         |  |  |  |  |
| Package  | SMF (DO-219AB) |  |  |  |  |
| Circuit configuration                          | Single         |  |  |  |  |

### FEATURES

• Hyperfast recovery time, reduced Q<sub>rr</sub>, and soft recovery



COMPLIANT HALOGEN

FREE

- 175 °C maximum operating junction temperature
- Specified for output and snubber operation
- · Low forward voltage drop
- · Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- Wave and reflow solderable
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **DESCRIPTION / APPLICATIONS**

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop and hyperfast recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber boost, lighting, as high frequency rectifiers, and freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

## **MECHANICAL DATA**

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Halogen-free, RoHS-compliant

**Terminals:** matte tin plated leads, solderable per J-STD-002

Polarity: color band denotes cathode end

| ABSOLUTE MAXIMUM RATINGS                         |                                   |  |             |       |  |  |  |
|--|-----------------------------------|--|-------------|-------|--|--|--|
| PARAMETER  | SYMBOL                            | TEST CONDITIONS                              | VALUES      | UNITS |  |  |  |
| Peak repetitive reverse voltage                  | V <sub>RRM</sub>                  |  | 200         | V     |  |  |  |
| Average rectified forward current                | I <sub>F(AV)</sub>                | $T_{\rm C} = 150 \ ^{\circ}{\rm C} \ ^{(1)}$ | 2           | ٨     |  |  |  |
| Non-repetitive peak surge current                | I <sub>FSM</sub>                  | T <sub>J</sub> = 25 °C                       | 50          | A     |  |  |  |
| Operating junction and storage temperature range | T <sub>J</sub> , T <sub>Stg</sub> |  | -65 to +175 | °C    |  |  |  |

Note

<sup>(1)</sup> Device on PCB with 8 mm x 16 mm soldering lands

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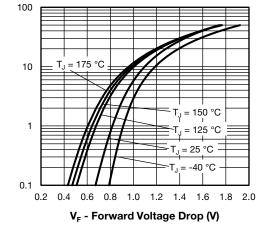
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| <b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C unless otherwise specified) |                                  |   |      |      |      |       |
|--|----------------------------------|---|------|------|------|-------|
| PARAMETER  | SYMBOL                           | TEST CONDITIONS                                 | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage  | V <sub>BR</sub> , V <sub>R</sub> | I <sub>R</sub> = 100 μA                         | 200  | -    | -    |       |
| Forward voltage  | V <sub>F</sub>                   | $I_F = 2 A$                                     | -    | 0.88 | 0.95 | V     |
| Forward voltage  | ۷F                               | I <sub>F</sub> = 2 A, T <sub>J</sub> = 125 °C   | -    | 0.75 | 0.82 |       |
| Reverse leakage current  | I <sub>R</sub>                   | $V_{R} = V_{R}$ rated                           | -    | -    | 2    |       |
| neverse leakage current  |                                  | $T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$ | -    | 1    | 8    | μA    |
| Junction capacitance   | CT                               | V <sub>R</sub> = 200 V                          | -    | 8    | -    | pF    |

| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified) |                  |   |  |      |      |      |       |
|---|------------------|---|--|------|------|------|-------|
| PARAMETER   | SYMBOL           | TEST CO   | NDITIONS   | MIN. | TYP. | MAX. | UNITS |
|   |                  | $I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}$    | õs, V <sub>R</sub> = 30 V  | -    | 24   | -    |       |
| Bayaraa raaayary tima   | +                | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> | = 0.25 A   | -    | -    | 25   | ns    |
| Reverse recovery time   | t <sub>rr</sub>  | T <sub>J</sub> = 25 °C  |  | -    | 16   | -    |       |
|   |                  | T <sub>J</sub> = 125 °C                                       | I <sub>F</sub> = 2 A<br>dI <sub>F</sub> /dt = 200 A/µs<br>V <sub>R</sub> = 160 V | -    | 22   | -    |       |
| Deals reasoning as meant  |                  | T <sub>J</sub> = 25 °C  |  | -    | 2    | -    | •     |
| Peak recovery current   | I <sub>RRM</sub> | T <sub>J</sub> = 125 °C                                       |  | -    | 3    | -    | A     |
|   | 0                | T <sub>J</sub> = 25 °C  |  | -    | 16   | -    | nC    |
| Reverse recovery charge   | Q <sub>rr</sub>  | T <sub>J</sub> = 125 °C                                       |  | -    | 30   | -    | 10    |

| THERMAL - MECHANICAL SPECIFICATIONS            |                                   |  |      |        |      |       |  |
|--|-----------------------------------|--|------|--------|------|-------|--|
| PARAMETER                                      | SYMBOL                            | TEST CONDITIONS  | MIN. | TYP.   | MAX. | UNITS |  |
| Maximum junction and storage temperature range | T <sub>J</sub> , T <sub>Stg</sub> |  | -65  | -      | 175  | °C    |  |
| Thermal resistance, junction to mount          | R <sub>thJM</sub>                 | Device mounted on PCB with 8 mm x 16 mm soldering lands  | -    | -      | 15   | °C/W  |  |
| Thermal resistance, junction to ambient        | R <sub>thJA</sub>                 | Device mounted on PCB with 2 mm x 3.5 mm soldering lands | -    | -      | 130  | °C/W  |  |
| Approvimete weight                             |                                   |  |      | 0.015  |      | g     |  |
| Approximate weight                             |                                   |  |      | 0.0005 |      | oz.   |  |
| Marking device                                 |                                   | Case style SMF (DO-219AB)                                |      | М      | EH   |       |  |







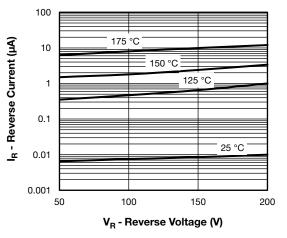


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

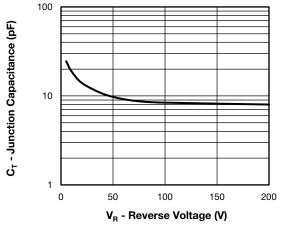
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Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

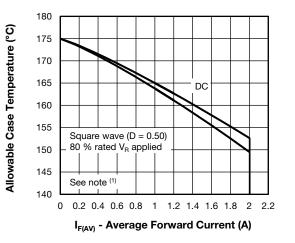


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

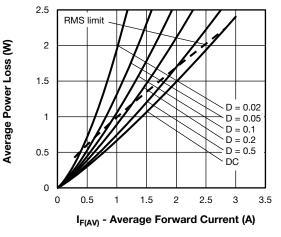


Fig. 5 - Forward Power Loss Characteristics

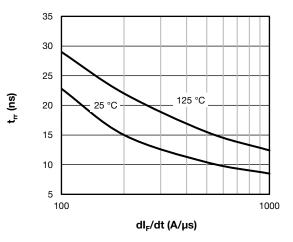


Fig. 6 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

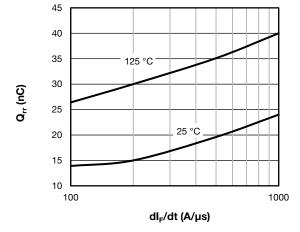


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

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<sup>&</sup>lt;sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;

 $<sup>\</sup>begin{array}{l} \mathsf{Pd} = \mathsf{forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \ x \ \mathsf{V}_{\mathsf{FM}} \ at \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see} \ \mathsf{fig.} \ \mathsf{5}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \ x \ \mathsf{I}_{\mathsf{R}} \ (1 - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ at \ \mathsf{V}_{\mathsf{R1}} = \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$ 

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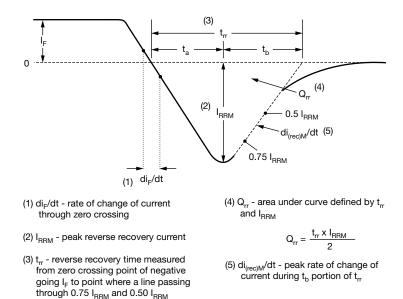


Fig. 8 - Reverse Recovery Waveform and Definitions

### **ORDERING INFORMATION TABLE**

SHAY

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| Device code | VS-                                     | 2   | E  | F      | н                   | 02     | -M3       |
|-------------|---|---|--|--------|---------------------|--------|-----------|
|             | 1                                       | 2   | 3  | 4      | 5                   | 6      | 7         |
|             | 2 · · · · · · · · · · · · · · · · · · · | - Cur<br>- Circ<br>E =<br>- F =<br>- Pro<br>H = | rent rati<br>cuit con<br>single c<br>SMF pa<br>cess typ<br>hyperfa | ackage | 2 A)<br>in:<br>very | oduct  |           |
|             | 6<br>7                                  |   | 0  |        | ,                   | -compl | iant, and |

extrapolated to zero current.

| ORDERING INFORMATION (Example) |  |        |                                   |  |  |  |  |
|--------------------------------|--|--------|-----------------------------------|--|--|--|--|
| PREFERRED P/N                  | QUANTITY PER REEL MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION |        |                                   |  |  |  |  |
| VS-2EFH02-M3/I                 | 10 000   | 10 000 | 13"diameter plastic tape and reel |  |  |  |  |

| LINKS TO RELATED DOCUMENTS          |                          |  |  |  |  |
|-------------------------------------|--------------------------|--|--|--|--|
| Dimensions www.vishay.com/doc?95572 |                          |  |  |  |  |
| Part marking information            | www.vishay.com/doc?95618 |  |  |  |  |
| Packaging information               | www.vishay.com/doc?95577 |  |  |  |  |
| SPICE model                         | www.vishay.com/doc?96013 |  |  |  |  |

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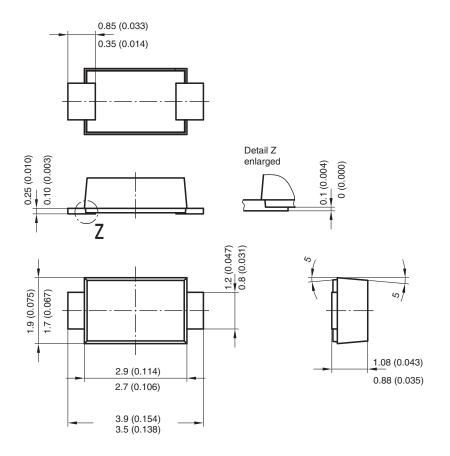
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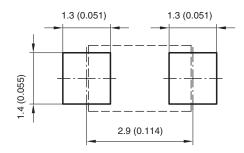
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# SMF (DO-219AB)

### **DIMENSIONS** in millimeters (inches)



Foot print recommendation:



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